

Features

- Ultra low capacitance: 0.5pF typical
- Ultra low leakage: nA level
- Low operating voltage: 3.3V
- Low clamping voltage
- 2-pin leadless package
- Complies with following standards:
 - – IEC 61000-4-2 (ESD) immunity test
 - Air discharge: ±30kV
 - Contact discharge: ±30kV
 - – IEC61000-4-5 (Lightning)4A (8/20μs)
- RoHS Compliant
- Lead Finish: NiPdAu

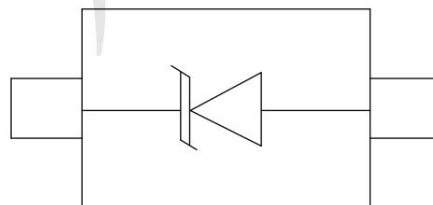
Mechanical Characteristics

- Package: SOD-923 (0402)
- Lead Finish: Matte Tin
- Case Material: “Green” Molding Compound.
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections: See Diagram Below
- Shipping Qty : 10000pcs/7Inch Tape & Reel

Applications

- Smart Phone and Tablet PC
- TV and Set Top Box
- Wearable Devices
- PDA

Dimensions and Pin Configuration



SOD923

Marking: X

Absolute Maximum Ratings (Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	Ppk	60	W
Peak Pulse Current (8/20μs)	Ipp	4	A
ESD per IEC 61000-4-2 (Air)	VESD	±30	kV
ESD per IEC 61000-4-2 (Contact)		±30	
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			3.3	V	
Breakdown Voltage	VBR	5.8			V	IT = 1mA
Reverse Leakage Current	IR			0.08	uA	VRWM = 3.3V
Clamping Voltage	VC			8	V	Ipp=1A(8x 20us pulse)
Clamping Voltage	VC			14	V	Ipp=4A(8x 20us pulse)
Junction Capacitance	CJ		0.5	0.9	pF	VR = 0V, f = 1MHz

Characteristic Curves

Fig1. 8/20 μ s Pulse Waveform

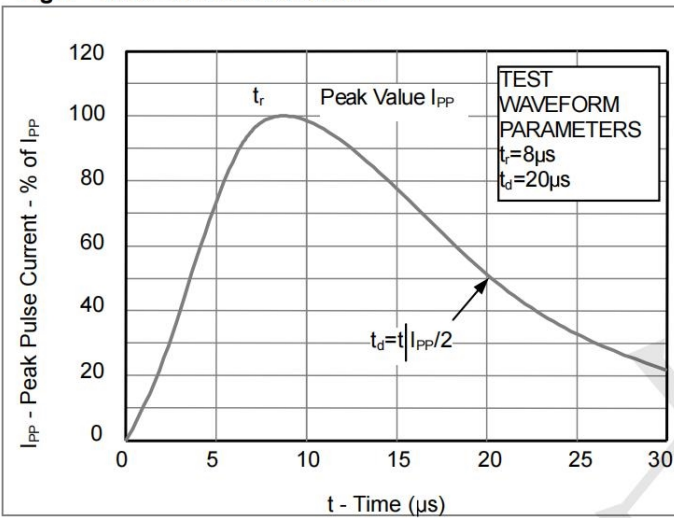


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

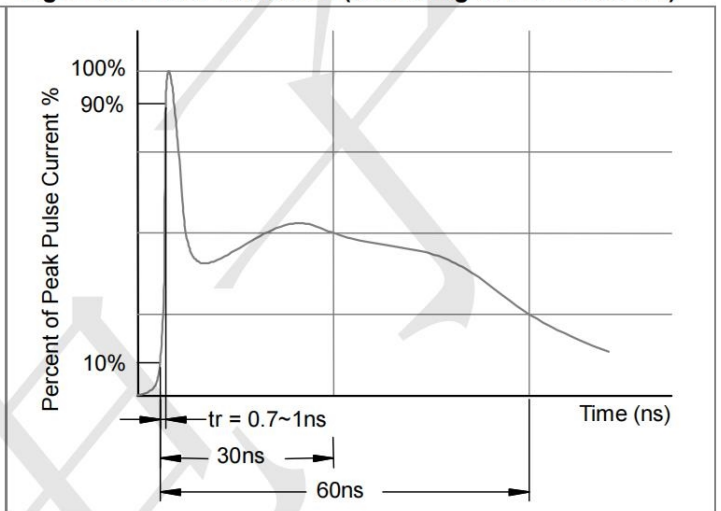
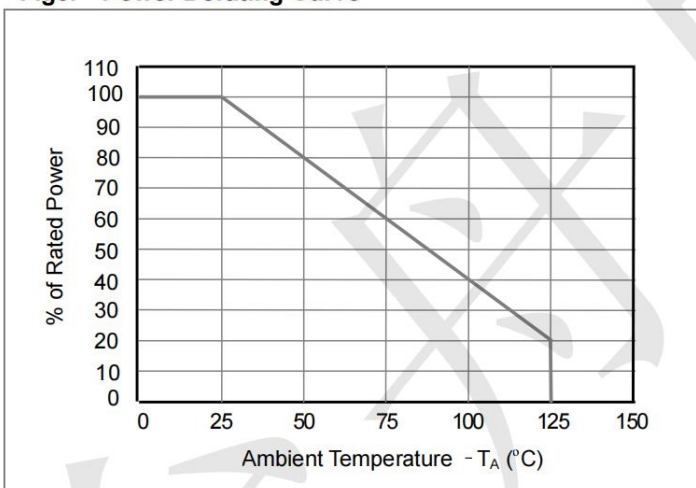
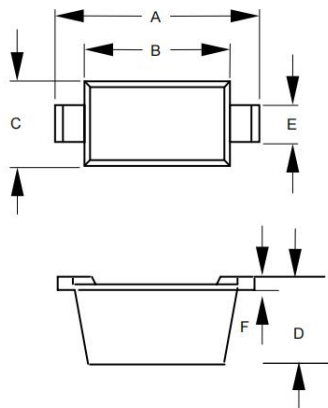


Fig3. Power Derating Curve



Outline Drawing - SOD-923(0402)



DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	.037	.041	0.95	1.05	
B	.030	.033	0.75	0.85	
C	.022	.026	0.55	0.65	
D	.014	.017	0.36	0.43	
E	.006	.010	0.15	0.25	
F	.003	.007	0.07	0.17	

Land Pattern - SOD-923(0402)

